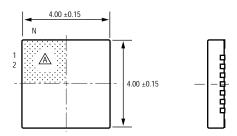
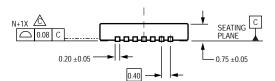
Designator: EC

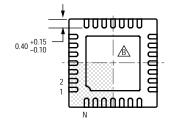
**Type: QFN** 

Package type representative configuration.

For contact count and device reference dimensions, refer to the datasheet for the individual device











Standard Branding Reference View

N = Last two digits of device part number Y = Last two digits of year of manufacture W = Week of manufacture

L = Lot number

For Reference Only (reference JEDEC MO-220) Dimensions in millimeters Exact case and lead configuration at supplier discretion

A Terminal #1 mark area

Exposed thermal pad (reference only, terminal #1 identifier appearance at supplier discretion)

Coplanarity includes exposed thermal pad and terminals

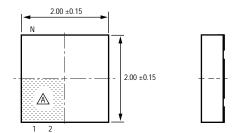
Branding scale and appearance at supplier discretion

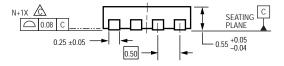
Designator: EE

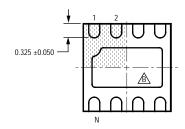
**Type: DFN** 

Package type representative configuration.

For contact count and device reference dimensions, refer to the datasheet for the individual device











Standard Branding Reference View

N = Last two digits of device part number Y = Last two digits of year of manufacture W = Week of manufacture

For Reference Only (reference JEDEC MO-229) Dimensions in millimeters Exact case and lead configuration at supplier discretion

A Terminal #1 mark area

Exposed thermal pad (reference only, terminal #1 identifier appearance at supplier discretion)

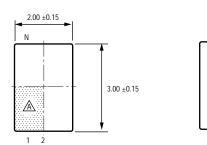
Coplanarity includes exposed thermal pad and terminals

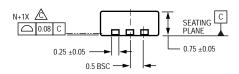
Branding scale and appearance at supplier discretion

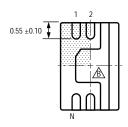
Designator: EH

**Type: DFN** 

Package type representative configuration. For contact count and device reference dimensions, refer to the datasheet for the individual device











Standard Branding Reference View

Y = Last two digits of year of manufacture

W = Week of manufacture L = Lot number

N = Last two digits of device part number

For Reference Only (reference JEDEC MO-229) Dimensions in millimeters Exact case and lead configuration at supplier discretion

A Terminal #1 mark area

Exposed thermal pad (reference only, terminal #1 identifier appearance at supplier discretion)

Coplanarity includes exposed thermal pad and terminals

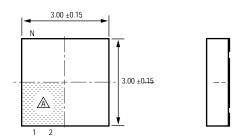
Branding scale and appearance at supplier discretion

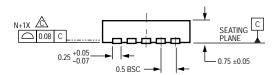
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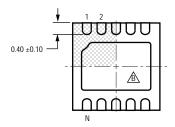
Designator: EJ

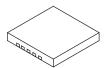
**Type: DFN** 

Package type representative configuration. For contact count and device reference dimensions, refer to the datasheet for the individual device











Standard Branding Reference View

L = Lot numver N = Last two digits of device part number

Y = Last two digits of year of manufacture

W = Week of manufacture

For Reference Only (reference JEDEC MO-229) Dimensions in millimeters Exact case and lead configuration at supplier discretion

A Terminal #1 mark area

Exposed thermal pad (reference only, terminal #1 identifier appearance at supplier discretion)

Coplanarity includes exposed thermal pad and terminals

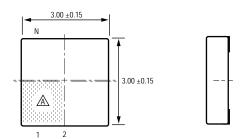
Branding scale and appearance at supplier discretion

Designator: EK

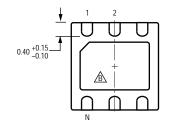
**Type: DFN** 

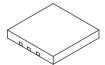
Package type representative configuration.

For contact count and device reference dimensions, refer to the datasheet for the individual device











Standard Branding Reference View

L = Lot numver

N = Last two digits of device part number

Y = Last two digits of year of manufacture

W = Week of manufacture

For Reference Only (reference JEDEC MO-229) Dimensions in millimeters Exact case and lead configuration at supplier discretion

A Terminal #1 mark area

Exposed thermal pad (reference only, terminal #1 identifier appearance at supplier discretion)

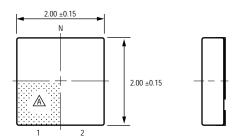
Coplanarity includes exposed thermal pad and terminals

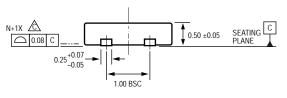
Branding scale and appearance at supplier discretion

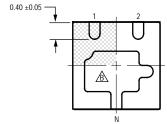
Designator: EL

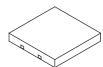
**Type: DFN** 

Package type representative configuration.
For contact count and device reference dimensions, refer to the datasheet for the individual device











Standard Branding Reference View

N = Last two digits of device part number Y = Last two digits of year of manufacture W = Week of manufacture

For Reference Only (reference JEDEC MO-229) Dimensions in millimeters Exact case and lead configuration at supplier discretion

A Terminal #1 mark area

Exposed thermal pad (reference only, terminal #1 identifier appearance at supplier discretion)

Coplanarity includes exposed thermal pad and terminals

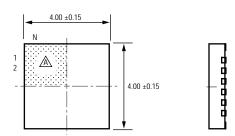
Branding scale and appearance at supplier discretion

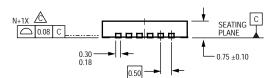
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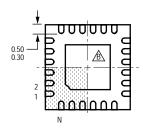
**Type: QFN** 

Package type representative configuration.

For contact count and device reference dimensions, refer to the datasheet for the individual device











L = Lot number

N = Last two digits of device part number

Y = Last two digits of year of manufacture

W = Week of manufacture

For Reference Only (reference JEDEC MO-220) Dimensions in millimeters Exact case and lead configuration at supplier discretion

A Terminal #1 mark area

Exposed thermal pad (reference only, terminal #1 identifier appearance at supplier discretion)

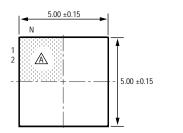
Coplanarity includes exposed thermal pad and terminals

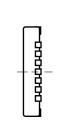
Branding scale and appearance at supplier discretion

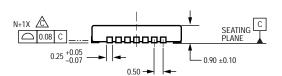
Designator: ET

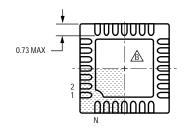
**Type: QFN** 

Package type representative configuration. For contact count and device reference dimensions, refer to the datasheet for the individual device













 $\mathcal{A}$  = Supplier emblem

L = Lot identifier

N = Device part number

Y = Last two digits of year of manufacture W = Week of manufacture

For Reference Only (reference JEDEC MO-220) Dimensions in millimeters Exact case and lead configuration at supplier discretion

A Terminal #1 mark area

Exposed thermal pad (reference only, terminal #1 identifier appearance at supplier discretion)

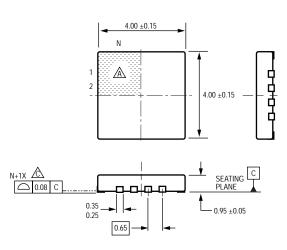
Coplanarity includes exposed thermal pad and terminals

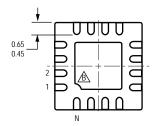
Branding scale and appearance at supplier discretion

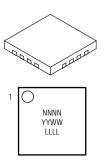
Designator: EU

**Type: QFN** 

Package type representative configuration. For contact count and device reference dimensions, refer to the datasheet for the individual device







L = Lot identifier

N = Device part number

Y = Last two digits of year of manufacture W = Week of manufacture

For Reference Only (reference JEDEC MO-220) Dimensions in millimeters Exact case and lead configuration at supplier discretion

A Terminal #1 mark area

Exposed thermal pad (reference only, terminal #1 identifier appearance at supplier discretion)

Coplanarity includes exposed thermal pad and terminals

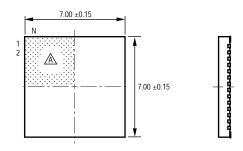
Branding scale and appearance at supplier discretion

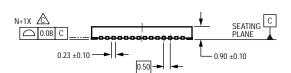
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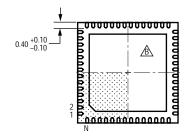
Designator: EV

**Type: QFN** 

Package type representative configuration. For contact count and device reference dimensions, refer to the datasheet for the individual device











 $\mathcal{A}$  = Supplier emblem

L = Lot identifier

N = Device part number

Y = Last two digits of year of manufacture W = Week of manufacture

For Reference Only (reference JEDEC MO-220)

Dimensions in millimeters

Exact case and lead configuration at supplier discretion

A Terminal #1 mark area

Exposed thermal pad (reference only, terminal #1 identifier appearance at supplier discretion)

Coplanarity includes exposed thermal pad and terminals

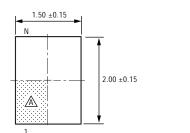
h Branding scale and appearance at supplier discretion

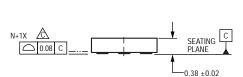
Designator: EW

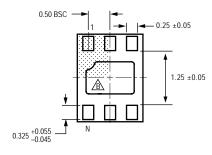
**Type: DFN** 

Package type representative configuration.

For contact count and device reference dimensions, refer to the datasheet for the individual device











Standard Branding Reference View

N = Device part number

Y = Last two digits of year of manufacture

W = Week of manufacture

For Reference Only (reference JEDEC MO-229) Dimensions in millimeters Exact case and lead configuration at supplier discretion

A Terminal #1 mark area

Exposed thermal pad (reference only, terminal #1 identifier appearance at supplier discretion)

A Coplanarity includes exposed thermal pad and terminals

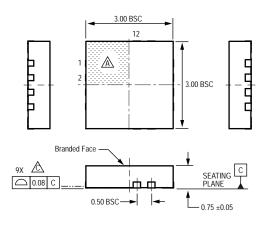
Branding scale and appearance at supplier discretion

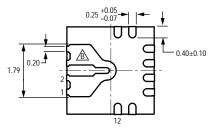


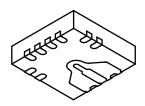
Designator: EX

**Type: QFN** 

Package type representative configuration. For contact count and device reference dimensions, refer to the datasheet for the individual device









#### Standard Branding Reference View

N = Device part number Y = Last two digits of year of manufacture W = Week of manufacture

L = Lot number

For reference only, not for tooling use (reference JEDEC MO-220WEED except for fused current path) Dimensions in millimeters

Exact case and lead configuration at supplier discretion within limits shown

A Terminal #1 mark area

B Fused sensed current path

Coplanarity includes exposed current path and terminals

Branding scale and appearance at supplier discretion